IPC ASSOCIATION CON ELECTRONICS INC	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both lev	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfg Information			
upplier In	nformation						·							
Company name*			Company unique ID			U	Unique ID Authority				Response Date*			
nsemi										2024-05-15				
Contact Name	e	Title - Contact			P	Phone - Contact*				Email - Contact*				
Product-Env-	-Stewards		Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com			
uthorized Re	epresentative*	Title - Representative			P	Phone - Representative*				Email - Representative*				
Product-Env-	-Stewards	Product Enviro Compliance			ı	NA				Product-Env-Stewards@onsemi.com				
Re	equester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	Ma	anufacturing Site		Weight*	UOM	Unit Type
	ES1DAF		ī	SFR SMAF PN 1A 200V		:	2024-05-15 CNP		NP	3	34.7001	mg	Each	
	ring Process Information Orid Array N		Comminal Dago	Allow	CTD 020 MCI D	Datin a	Dools Duo oo	as Dody Tom		May Time at Peak	Tomomorat	Name Name	on of Baflayy Cyc	Jac
2 ,		-		STD-020 MSL R	cating	260		Body Temperature Max Time at Peak C 30				er of Reflow Cyc	eies	
•	atte Tin (Sn) - annealed	Į (CU Alloy	1			200			30	secon	ds 3		
omments		4		20 1-										
	mum time at peak tempera													
r more info	ormation regarding materia	ai composition	piease refer to	o page 3										

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s	s) does not contain RoHS restricted substance	ces per the definition above except for selected exer	nptions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead). Exemption: 7c-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature R		,								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	3.02	mg	Supplier	Iron (Fe)	7439-89-6		0.003	mg
			Supplier	Copper (Cu)	7440-50-8		3.0161	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0009	mg
Die	0.7	mg	Supplier	Silicon (Si)	7440-21-3		0.6541	mg
			В	Nickel (Ni)	7440-02-0		0.0081	mg
			Supplier	Lead Bisilicate	65997-18-4	7c	0.0378	mg
Die Attach Solder	1.7101	mg	Supplier	Silver (Ag)	7440-22-4		0.0428	mg
			A	Lead (Pb)	7439-92-1	7a	1.5818	mg
			Supplier	Tin (Sn)	7440-31-5		0.0855	mg
Lead Frame	10.67	mg	Supplier	Iron (Fe)	7439-89-6		0.0107	mg
			Supplier	Copper (Cu)	7440-50-8		10.6561	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0032	mg
Mold Compound-Black	18.4	mg	Supplier	(10-(2,5-Dihydroxyphenyl)-10H-9-oxa- 10-phospha-phenantbrene-10-oxide)	99208-50-1		0.276	mg
			Supplier	Carbon Black (C)	1333-86-4		0.092	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.276	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		13.8	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		2.576	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.38	mg
Plating	0.2	mg	Supplier	Tin (Sn)	7440-31-5		0.2	mg